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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/068,159	02/05/2002	Hock Chuan Tan	MTI-31608	MTI-31608 8043	
22202 7	590 08/16/2005		EXAM	EXAMINER	
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555 EAST WE SUITE 1900	LLS STREET		ART UNIT	ART UNIT PAPER NUMBER	
MILWAUKEE, WI 53202			2818	2818	
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Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)	
	10/068,159	TAN ET AL.	OM
Office Action Summary	Examiner	Art Unit	
	Thao P. Le	2818	
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the	correspondence add	lress -
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply If NO period for reply is specified above, the maximum statutory period v - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	. 36(a). In no event, however, may a reply be to within the statutory minimum of thirty (30) day ill apply and will expire SIX (6) MONTHS from cause the application to become ABANDON	imely filed ays will be considered timely. the mailing date of this cor IED (35 U.S.C. § 133).	
Status			
Responsive to communication(s) filed on 12 Au This action is FINAL. 2b) ☑ This Since this application is in condition for allowar closed in accordance with the practice under E	action is non-final. nce except for formal matters, pr		merits is
Disposition of Claims			
4) ☐ Claim(s) See Continuation Sheet is/are pendin 4a) Of the above claim(s) is/are withdray 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 1-14, 24-31, 33-38, 47-50, 52, 112-11 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/or	vn from consideration. 9, 124-127, 137-139, 141, 144,	<u>146, 149-161</u> is/are	e rejected.
Application Papers			
9) The specification is objected to by the Examine 10) The drawing(s) filed on is/are: a) accomplicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Ex	epted or b) objected to by the drawing(s) be held in abeyance. So ion is required if the drawing(s) is o	ee 37 CFR 1.85(a). bjected to. See 37 CFI	
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the priority application from the International Bureau * See the attached detailed Office action for a list	s have been received. s have been received in Applica rity documents have been receiv (PCT Rule 17.2(a)).	tion Noved in this National S	Stage
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date 7 pages.	4) Interview Summar Paper No(s)/Mail I 5) Notice of Informal 6) Other:		·152)

Art Unit: 2818

DETAILED ACTION

Claims 1-14, 24-31, 33-38, 47-50, 52, 112-119, 124-127, 137-139, 141, 144, 146, 149-161 are pending.

Claim Rejections

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless --

- (a) the invention was known or used by others in this country, or patented or described in a printed publication in this or a foreign country, before the invention thereof by the applicant for a patent.
- (e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 1-7, 11, 24-25, 33, 112-114, 124, 125, 149-150, 144, 146, 149-153, 160 are rejected under 35 USC 102 (a) as being anticipated by Tuckerman et al., U.S. Patent No. 5,804,004.

Regarding to claims 1-4, 24-25, 33, 112, 124, 144, 146, 149-153, 160, Tuckerman et al discloses a stacked die assembly, comprising at least two

Art Unit: 2818

semiconductors dies (150A, 150CB) disposed on a substrate in a stacked arrangement, the substrate comprising a first surface having terminal pads disposed thereon (Fig. 4A); a first die 150A disposed on the first surface of the substrate having bond pads; a second die 150B comprising a first surface, a second surface, and a perimeter, the first surface having bond pads disposed thereon (top surface of die 150B), the second surface (attaching layer 188) having a recessed edge portion 190, the first die disposed within the recessed edge, the recessed edge portion having a height sufficient for clearance of the bonding elements extending from the bond pads of the first die (See Figs. 4A and 8). Still regarding claims 24-25, 124, Tuckerman et al discloses a third die 150C having a recessed edge portion and the second die disposed in the recessed edge portion of the third die.

Regarding claims 5-7, 28-29, 34-36, 113, 152, Tuckerman et al discloses bonding elements 189, 190 connecting the bond pads of the second die to the terminal pads on the substrate and at least one of an adhesive element disposed between the first die and substrate, between the second and first dies, second and third dies (182, 170, 188).

Regarding claims 11, 114, Tuckerman et al discloses the bonding element comprises a wire bond.

Regarding claim 125, Tuckerman et al discloses mounting the first die comprises a flip chip attachment.

Art Unit: 2818

Akram, U.S. Patent No. 6,351,028 also discloses the limitations of claims 1-4, 24-25, 33, 112, 124, 144, 146, 149-153, 160.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 8, 9, 26-27, 30-31, 37-38, 52, 119126-127, 137-139, 141, 144, 153 rejected under 35 U.S.C. 103(a) as being unpatentable over Tuckerman et al., U.S. patent No. 5,804,004, in view of Zuhr Bernhard, DE 10209204 (IDS).

Regarding claims 26-27, Tuckerman et al. fails to disclose the recess is square, rectangular, oval, or circular shaped, however, Zuhr Bernhard discloses the recess is square. It would have been obvious to one having ordinary skill in the art at the time the invention was made to form a recess having square, rectangular, oval, or circular shaped because such shapes of the recess would provide a clearance for another die

Art Unit: 2818

or bond pads formed inside although the shape of the recess does not impart on the functions, manners, characteristics of the stacked assembly.

Regarding claims 8, 9, 30-31, 37-38, 52, 119126-127, 137-139, 141, 144, 153, it would have been obvious that the adhesive element comprises a tape adhesive and it would have been obvious to have the length and width of the second die is greater than the first die since the selection of the parameters such as energy, concentration, temperature, time, molar fraction, depth, thickness, etc., would have been obvious and involve routine optimization which has been held to be within the level of ordinary skill in the art. "Normally, it is to be expected that a change in energy, concentration, temperature, time, molar fraction, depth, thickness, etc., or in conbination of the parameters would be an unpatentable modification. Under some circumstances, however, changes such as these may impart patentability to a process if the particular ranges claimed produce a new and unexpected result which is different in kind and not merely degree from the results of the prior art ... such ranges are termed "critical ranges and the applicant has the burden of proving such criticality.... More particularly, where the general conditions of a claim are disclosed in the prior art, it is not inventive to discover the optimum or workable ranges by routine experimentation." In re Aller 105 USPQ233, 255 (CCPA 1955). See also In re Waite 77 USPQ 586 (CCPA 1948); In re Scherl 70 USPQ 204 (CCPA 1946); In re Irmscher 66 USPQ 314 (CCPA 1945); In re Norman 66 USPQ 308 (CCPA 1945); In re Swenson 56 USPQ 372 (CCPA 1942); In re Sola 25 USPQ 433 (CCPA 1935); In re Dreyfus 24 USPQ 52 (CCPA 1934).

Art Unit: 2818

Regarding claims 12-14, 47-50, 115-119-126-127, 137-139, 141, 154-161, Zuhr Bernhard discloses the assembly is partially encapsulated and substrate having a leadframe, the substrate is selected from the group consisting of epoxy resin, ceramics, polyimide resins. It is inherent that the apparatus of Tuckerman and Zuhr Bernhard is selected from the group consisiting of a PCB, motherboard, program logic controller, and testing apparatus and the apparatus is in electrical communication with an electrical apparatus.

When responding to the office action, Applicants' are advice to provide the examiner with the line numbers and page numbers in the application and/or references cited to assist the examiner to locate the appropriate paragraphs.

A shortened statutory period for response to this action is set to expire 3 (three) months and 0 (zero) day from the day of this letter. Failure to respond within the period for response will cause the application to become abandoned (see M.P.E.P 710.02(b)).

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Thao P. Le whose telephone number is 571-272-1785. The examiner can normally be reached on M-T (7-6).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, David Nelms can be reached on 571-272-1787. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Art Unit: 2818

Page 7

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Thao P. Le

Art Unit 2818

Continuation of Disposition of Claims: Claims pending in the application are 1-14,24-31,33-38,47-50,52,112-119,124-127,137-139,141,144,146 and 149-161.